Supporting Information For:

2D Ultrathin Core-shell Pd@Pt_{monolayer} Nanosheets: Defect-Mediated Thin Film Growth and Enhanced Oxygen Reduction Performance

Wenxin Wang,^{a,b} Yunfeng Zhao,^{a,*}and Yi Ding^{a,*}

^a Institute for New Energy Materials & Low-Carbon Technologies, School of Materials Science and Engineering, Tianjin University of Technology, Tianjin 300384, China. Email: yding@tjut.edu.cn, yunfeng.zhao@kaust.edu.sa; Tel: +86-22-60216546

^b Center for Advanced Energy Materials & Technology Research (AEMT), School of Chemistry and Chemical Engineering, Shandong University, Jinan 250100, China.

Experimental Section

Materials and methods

Pd@Ptmonolaver ultrathin nanoplate fabrication

Pd nanoplates were synthesized by a colloidal method proposed by Zheng and co-workers¹. Pd(acac)₂ (50.0 mg), CTAB (185.0 mg), PVP (160.0 mg) and 10 mL benzyl alcohol were mixed at room temperature and saturated with carbon monoxide (CO) gas. After heating the mixture for 3h at 70 °C, the dark blue precipitates were separated by centrifugation and further purified by ethanol for several times. These Pd

nanoplates were loaded onto a polished glassy carbon electrode (diameter = 5 mm, without Nafion®) for surface modification via a defect-mediated thin film growth method².

The surface modification was performed on a CHI 760D electrochemical workstation (Shanghai Chenhua Co., China), using a conventional three electrode cell with Pt foil as the counter electrode and reversible hydrogen electrode (RHE) as the reference electrode. Before cyclic voltammetry measurement, one cycle of potential sweep between 0.2 to 1.2 V at a sweep rate of 10 mV s⁻¹ was applied to clean the surfactant adsorbed on the Pd surface. According to the voltammetry curves for Cu UPD on Pd nanoplates, Pt was deposited by repeated potential cycles between 0.40 (bulk deposition potential of Cu) and 0.67 V (bulk deposition potential of Pt) for 15 times, followed by a final linear potential sweep to 1 V to remove Cu. After the treatment, Pd@Pt_{monolayer} materials were collected for subsequent characterization.

Physicochemical characterization

Power X-ray diffraction (XRD) pattern was measured by a Bruker D8 Advance X-ray diffractometer using Cu K α radiation (λ =1.5418 Å) with a scan rate of 0.04°s⁻¹. Transmission electron microscopy (TEM, JEM 1011) was operated at an acceleration voltage of 100 kV. Fine structure analyses were carried out with the high-angle annular dark-field scanning transmission electron microscopy (HAADF-STEM) operated at 300 kV, attached with energy-dispersive X-ray spectroscopy (EDS). All TEM samples were prepared by depositing a drop of diluted suspension in ethanol on

carbon film coated molybdenum grid. To measure the sample thickness, Pd nanoplates were dropped onto a mica substrate for atomic force microscopy (AFM, NanoScope IIIA) analyses under the tapping mode. Composition analyses of Pd and Pt were further confirmed with the inductively coupled plasma mass spectrometry (ICP-MS, IRIS Advantage spectrometer). Surface structures of Pd@Pt_{monolayer} were analyzed by means of X-ray photoelectron spectrometer (XPS, ESCALAB 250), using a monochromatized MgK α X-ray as the excitation source and choosing C1s (284.60 eV) as the reference line.

Electrochemical Testing

Pd@Pt_{monolayer} catalyst ink was prepared by mixing 200µL as-prepared ethanol suspension into 1 mL ethanol. The prepared catalyst ink solution (8µL) was then deposited onto a polished glassy carbon disc electrode (geometric surface area of 0.19625 cm^{-2}) leading to a loading of 48.2 µg cm⁻², followed by complete dry under ambient conditions. The electrode was then immersed into 50 mM H₂SO₄ at 30 °C by a circulating water bath, and all electrochemical surface modification and testing were carried out using a reference hydrogen electrode (RHE) and a platinum wire counter electrode. For CO stripping voltammetry, CO gas (99.99 %) was bubbled for 30 min first, following by N₂ gas bubbling for additional 30 min at 0.4 V. ORR activities were measured by using a PAR model 636 rotating disk electrode system in an O₂saturated 0.1 M HClO₄ solution at 30 °C, and the electrode rotation rate varied from 400 to 2500 rpm. Prior to the electrochemical measurements, the electrolytes were deoxygenated by bubbling N₂ for 20 min. Commercial carbon supported platinum (Pt/C) was tested for comparison with an electrode loading of $15\mu g_{Pt}$ cm⁻². As a result of substantial hydrogen adsorption, the electrochemical surface area (ECSA) from the hydrogen adsorption/desorption area was unreliable. Here we calculated ECSA of Pd nanoplates and Pd@Pt_{monolayer} by integrating the charge associated with reduction of surface Pt-O and Pd-O in 0.1 M N₂-purged HClO₄ electrolyte, by assuming a charge of 420 µC cm⁻². For commercial Pt/C catalyst, ESA was calculated from the hydrogen adsorption / desorption charge in the CV curve, by assuming a charge of 210 µC cm⁻². The ECSAs of Pd@Pt_{monolayer} and Pt/C were calculated to be 171.45 and 77.96 m² g_{Pt}⁻¹, respectively. Accelerated durability test (ADT) was carried out by continuous potentiodynamic sweep between 0.6-1.0 V in oxygen-saturated 0.1 M HClO₄ solution for 5000 cycles at 30 °C, with a reversible hydrogen electrode (RHE) working as the reference electrode at a scan rate of 50 mV s⁻¹.

Reagents: Pd(II) acetylacetonate (Pd(acac)₂) and HClO₄ (G.R.) were produced by Aladdin Co. Ltd. Poly(vinylpyrrolidone) (PVP) (MW=30000), Cetyltrimethylammonium bromide (CTAB), benzyl alcohol, H₂SO₄ (A.R.), CuSO₄ \Box 5H₂O (A.R.), H₂PtCl₄ (A.R.) were purchased from Sinopharm Chemical Reagent Co. Ltd. The Johnson Matthey Pt/C (20 wt%) catalysts was purchased from Alfa Aesar. The water used in all experiments was ultrapure (18.2 MΩ). All reagents were used as received without further purification.

References

- 1. X. Huang, S. Tang, X. Mu, Y. Dai, G. Chen, Z. Zhou, F. Ruan, Z. Yang and N. Zheng, *Nat. Nanotech.*, 2011, **6**, 28-32.
- 2. J. X. Wang, B. M. Ocko and R. R. Adzic, *Surf. Sci.*, 2003, **540**, 230-236.



Figure S1. (a) TEM image of Pd nanoplates. The scale bar stands for 150 nm. (b) AFM images of Pd nanoplates. The inset picture shows the z-axis height at selected

yellow region. The scale bar stands for 150 nm.



Figure S2. XRD pattern of as-prepared Pd nanoplates.



Figure S3. (a) CVs for Pd nanoplates in N₂-purged 50 mM H₂SO₄ solution at 10 mV s⁻¹ scan rate. (b) CO stripping curves for Pd nanoplates before (black solid line) and after (blue solid line) electrochemical surface cleaning, measured in N₂-purged 50

mM H_2SO_4 solution at 2 mV s⁻¹ scan rate.



Figure S4. ORR activity differences of Pd substrates before and after PVP removal from the surface, in O_2 saturated 0.1 M HClO₄ solution, using commercial Pt/C as a

reference.



Figure S5. Voltammetry curves for Cu UPD on Pd nanoplates (solid line) in N₂saturated solution containing 50 mM H₂SO₄ and 50 mM CuSO₄, together with a baseline voltammetric curve for Pd nanoplates in a solution without Cu (dash line).

Scan rate 10 mV s⁻¹.



Figure S6. CO stripping voltammetry curves of different materials in 50 mM H_2SO_4

solution at a scan rate of 2 mV s⁻¹.



Figure S7. (a) TEM image and (b) SAED pattern of Pd@Ptmonolayer catalyst. The scale

bar stands for 50 nm.



Figure S8. XPS spectra of (a) Pd 3*d* and (b) Pt 4*f* of Pd@Pt_{monolayer}.



Figure S9. Roughness parameters based on AFM measurement of (a) Pd nanoplates and (b) Pd@Pt_{monolayer}. Roughness average values (R_a) of Pd substrate and Pd@Pt_{monolayer} are 0.26 and 0.19 nm, respectively. And root mean square roughness values (R_q) of Pd substrate and Pd@Pt_{monolayer} are 0.32 and 0.25 nm, respectively.



Figure S10. TEM images of commercial Pt/C before (left) and after (right) 5000

cycles durability measurement in 0.1 M HClO₄ solution. Scale bar stands for 50 nm.



Figure S11. TEM images of Pd@Ptmonolayer before (left) and after (right) 5000 cycles

durability measurement in 0.1 M HClO₄ solution. Scale bar stands for 50 nm.